

TOSHIBA High Efficiency Diode Stack (HED) Silicon Epitaxial Type

U 2 0 D L 2 C 5 3 A

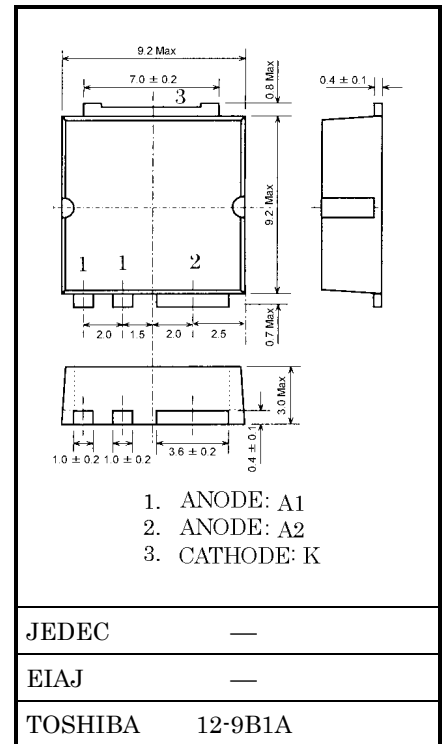
Switching Mode Power Supply Application
 Converter&Chopper Application

Unit: mm

- Repetitive peak reverse voltage: $V_{RRM} = 200$ V
- Average output recified current: $I_O = 20$ A
- Ultra fast reverse-recovery time: $t_{rr} = 35$ ns (max)
- Low switching losses and output noise.
- Power surface mount device for thin flat package.
 “TFP” (Toshiba package name)

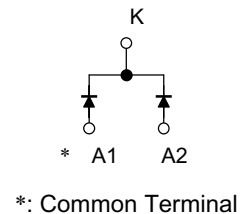
Maximum Ratings

Characteristics	Symbol	Rating	Unit
Repetitive peak reverse voltage	V_{RRM}	200	V
Average output recified current	I_O	20	A
Peak one cycle surge forward current (non-repetitive, sine wave)	I_{FSM}	100 (50 Hz)	A
		110 (60 Hz)	
Junction temperature	T_j	-40 to 150	°C
Storage temperature range	T_{stg}	-40 to 150	°C



Weight: 0.74 g

Polarity



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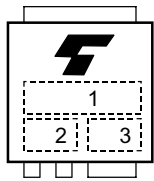
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Electrical Characteristics (Ta = 25°C)

Characteristics	Symbol	Test Condition	Min	Typ.	Max	Unit
Peak forward voltage	V_{FM}	$I_{FM} = 10 \text{ A}$	—	—	0.98	V
Repetitive peak reverse current	I_{RRM}	$V_{RRM} = 200 \text{ V}$	—	—	50	μA
Reverse recovery time	t_{rr}	$I_F = 2 \text{ A}$, $di/dt = -50 \text{ A}/\mu\text{s}$	—	—	35	ns
Thermal resistance	$R_{th(j-c)}$	DC Total, Junction to Case	—	—	1.5	$^{\circ}\text{C}/\text{W}$

Note: V_{FM} , I_{RRM} , t_{rr} : A value of one cell.

Marking



1	MARK	20DL2C	TYPE	U20DL2C53A
2	A			
3	Lot Number <input type="checkbox"/> <input type="checkbox"/> — Month (starting from alphabet A) <input type="checkbox"/> — Year (last number of the christian era)			

Standard Soldering Pad

